



P-CHANNEL ENHANCEMENT MODE MOSFET

Features

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- **ESD Protected**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

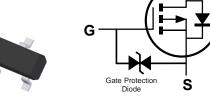
Mechanical Data

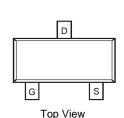
- Package: SOT23
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Terminal Connections: See Diagram Below
- Weight: 0.009 grams (Approximate)





SOT23 (Standard)





Top View

Internal Schematic

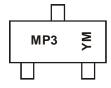
Ordering Information (Notes 4 & 5)

Orderable Part Number	Paakaga	Packing		
Orderable Part Number	Package	Qty.	Carrier	
DMP2035U-7	SOT23 (Standard)	3,000	7" Tape & Reel	
DMP2035U-13	SOT23 (Standard)	10,000	13" Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.
- 5. The ESD gate protection diode is only designed to protect against ESD events. No gate-source voltage greater than the maximum VGSS rating (given on page 2) can be applied.

Marking Information



MP3 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: M = 2025) M = Month (ex: 9 = September)

Date Code Key

Year	2011		2025	2026	2027	2028	2029	2030	2031	2032	2033	2034
Code	Υ		М	N	Р	R	S	Т	U	V	W	Χ
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		VDSS	-20	V	
Gate-Source Voltage	Vgss	±10	V		
Continuous Drain Current (Note 8) V _{GS} = -4.5V	lD	-4.9 -4.0	А		
Pulsed Drain Current (Note 8)		IDM	-24	Α	
Maximum Continuous Body Diode Forward Curren	Is	-1.2	A		
Pulsed Body Diode Forward Current (Note 10)			Ism	-24	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 6)	PD	0.81	W
Thermal Resistance, Junction to Ambient (Note 6)	Reja	153.5	°C/W
Total Power Dissipation (Note 7)	PD	1.2	W
Thermal Resistance, Junction to Ambient (Note 7)	Reja	100	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

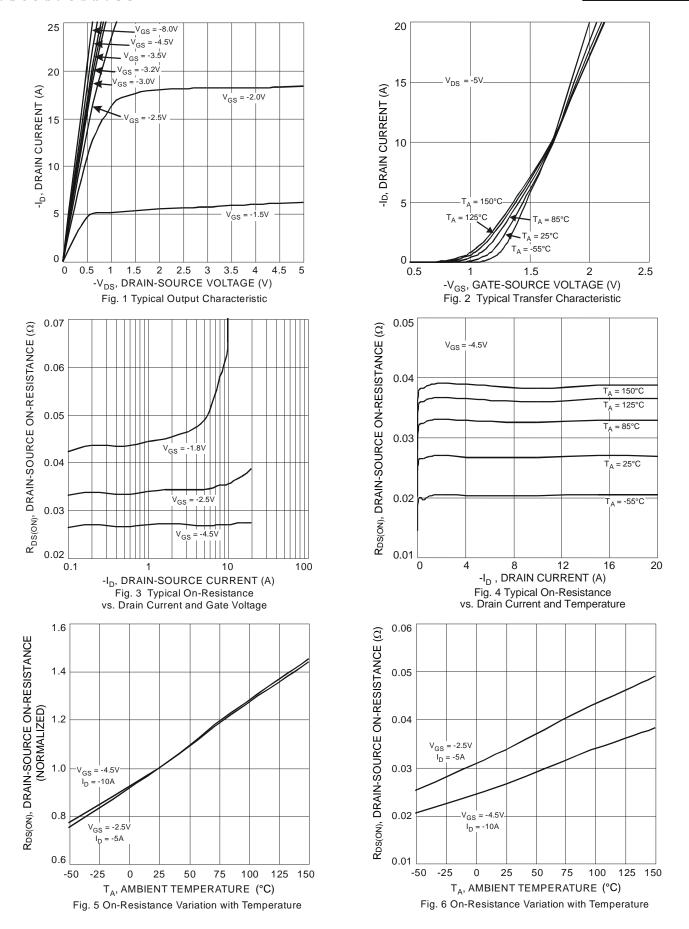
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition		
OFF CHARACTERISTICS (Note 9)								
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$		
Zero Gate Voltage Drain Current, T _J = +25°C	I _{DSS}	_	_	-1.0	μA	V _{DS} = -20V, V _{GS} = 0V		
Gate-Source Leakage	Igss	_	_	±10	μA	Vgs = ±8V, Vps = 0V		
ON CHARACTERISTICS (Note 9)	ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	Vgs(TH)	-0.4	-0.7	-1.0	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$		
			23	35		$V_{GS} = -4.5V$, $I_{D} = -4.0A$		
Static Drain-Source On-Resistance	RDS(ON)	_	30	45 62	mΩ	$V_{GS} = -2.5V$, $I_{D} = -4.0A$		
			41			Vgs = -1.8V, ID = -2.0A		
Forward Transfer Admittance	YFS	_	14	_	s	V _{DS} = -5V, I _D = -4A		
Diode Forward Voltage	VsD	_	-0.7	-1.0	V	VGS = 0V, IS = -1A		
DYNAMIC CHARACTERISTICS (Note 10)								
Input Capacitance	Ciss	_	1,610	_	pF			
Output Capacitance	Coss	_	157	_	pF	V _{DS} = -10V, V _{GS} = 0V - f = 1.0MHz		
Reverse Transfer Capacitance	Crss	_	145	_	pF	1 = 1.0MHZ		
Gate Resistance	Rg	_	9.45	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$		
Total Gate Charge	Qg	_	15.4	_	nC			
Gate-Source Charge	Q _{gs}	_	2.5	_	nC	Vgs = -4.5V, Vps = -10V,		
Gate-Drain Charge	Qgd	_	3.3	_	nC	I _D = -4A		
Turn-On Delay Time	t _{D(ON)}	_	16.8	_	ns			
Turn-On Rise Time	t _R	_	12.4	_	ns	$V_{DS} = -10V, V_{GS} = -4.5V,$		
Turn-Off Delay Time	tD(OFF)	_	94.1	_	ns	$R_L = 10\Omega$, $R_g = 6.0\Omega$, $I_D = -1A$		
Turn-Off Fall Time	tF	_	42.4	_	ns	1		

Notes:

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 7. Device mounted on FR-4 substrate PC board, 2oz copper, with 25mm x 25mm square copper plate.
- 8. Repetitive rating, pulse width limited by junction temperature.
- 9. Short duration pulse test used to minimize self-heating effect.
- 10. Guaranteed by design. Not subject to product testing.







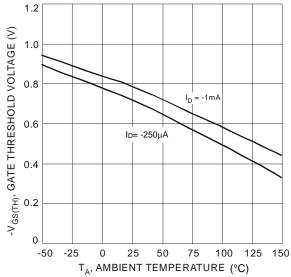
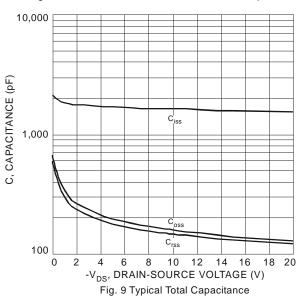
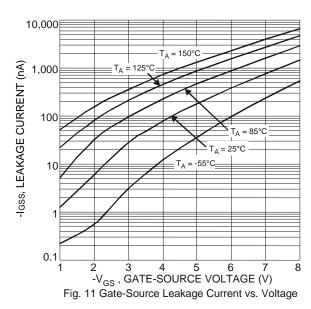
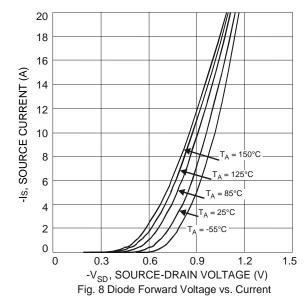
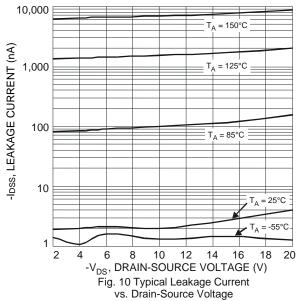


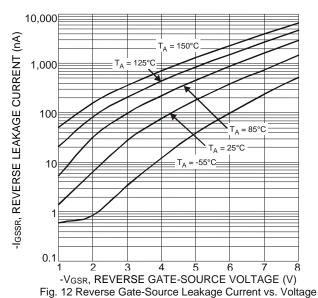
Fig. 7 Gate Threshold Variation vs. Ambient Temperature



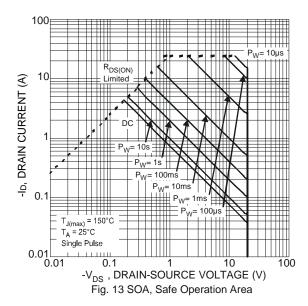












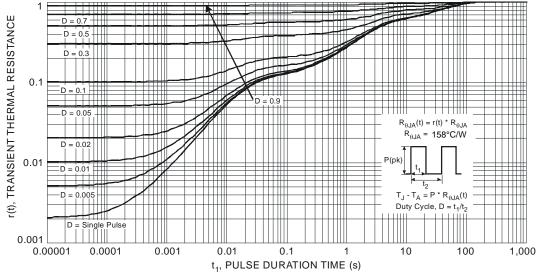


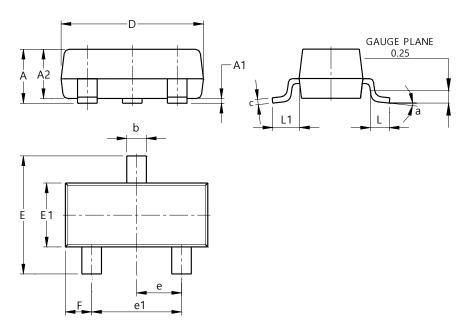
Fig. 14 Transient Thermal Response



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23 (Standard)

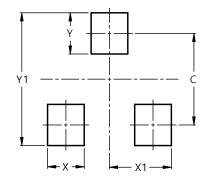


SOT23 (Standard)							
Dim	Min	Max	Тур				
Α	0.90	1.15	1.025				
A 1	0.00	0.10	0.05				
A2	0.85	1.10	0.975				
b	0.30	0.51	0.40				
С	0.080	0.202	0.11				
D	2.80	3.00	2.90				
Е	2.25	2.55	2.40				
E1	1.20	1.40	1.30				
е	0.89	1.03	0.915				
e1	1.78	2.05	1.83				
F	0.40	0.60	0.535				
L1	0.45	0.61	0.55				
L	0.25	0.55	0.40				
а	0°	8°					
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23 (Standard)



Dimensions	Value (in mm)				
С	2.0				
Х	0.8				
X1	1.35				
Υ	0.9				
Y1	2.9				

June 2025



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